



IEEE JRFID Special Issue on “News from CRFID meetings”

This **JRFID Special Issue** aims to collect the latest advances on RFID technology showed at the following 2023 international conferences sponsored by the Council on Radio Frequency Identification (CRFID):

- 2023 IEEE International Conference on RFID (RFID), June 13-15, 2023, Seattle, Washington, USA
- International Symposium on Advances in RFID Technology and Electromagnetics for IoT – SpliTech 2023, June 20-23, 2023, Island of Brac, Croatia
- IEEE International Conference on RFID ---Technology and Applications (RFID-TA), to be held on September 4-6, 2023, Aveiro, Portugal.

The manuscript **must be significantly extended** beyond the scope of the conference paper in terms of the overall technical contents and research results (a similarity percent match less than 30% is mandatory).

The submission deadline is December 1, 2023. Nevertheless, submissions in advance with respect to the deadline are strongly encouraged, since the accepted manuscripts will be published as Early Access documents on IEEE Xplore as soon as the final files are submitted by the authors.

Submission guidelines

The following requirements must be accounted for when submitting the manuscript:

1. The **manuscript must be technically extended** beyond the contents of the conference paper. The novelty aspects with respect to the conference paper must to be properly discussed and highlighted, through the text. Additionally, the authors must provide in the Cover Letter detailed information on how the manuscript is a technically-extended version of the conference paper.
2. In the manuscript, the conference paper **must** be listed as one of the references and clearly referred. A **pdf copy of the conference paper** must also be submitted.

The manuscript, together with the accompanying documents (i.e. cover letter, conference paper and IEEE copyright transfer form), must be submitted electronically using the Manuscript Central website <https://mc.manuscriptcentral.com/jrfid>, according to the format available at <https://journals.ieeeauthorcenter.ieee.org/>.

When uploading the manuscript select for your manuscript the following TYPE: “**CRFID Conferences 2023**”. Subsequently, do not forget to upload the Cover Letter and the conference paper as “Supplemental Files for Review”. Failure to follow above request will result in the immediate return of the manuscript to the author(s) as an unacceptable submission. For any questions on the submission process, please contact the Editor-in-Chief of IEEE JRFID, Prof. Paolo Nepa (paolo.nepa@unipi.it) or the Guest Editors.

Guest Editors:

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IMPORTANT DATES:

Submission deadline: DECEMBER 1, 2023 Publication of the Special Issue: mid 2024